

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

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It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 12, lines 17-20, claim 11, should read as follows:

11. The electronic component according to claim 10, including a mounting device selected from the group consisting of a printed circuit board and a ceramic substrate, and said solder formations mounted to said mounting device.

Signed and Sealed this

Twelfth Day of December, 2006



JON W. DUDAS
Director of the United States Patent and Trademark Office